

T-1 3/4 (5mm) Blinking LED Lamp

# **Features**

- $\bullet$  5mm package with built-in blinking IC
- Blinking frequency: 3.0Hz to 1.5Hz
- Operation voltage: 3.5V to 14V
- RoHS compliant.

Apr 13,2022

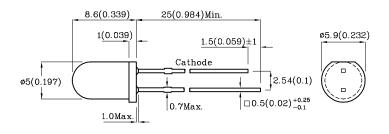




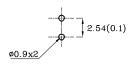


ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

# Package Schematics



Recommended PCB Layout



### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

| Absolute Maximum Ratings (T <sub>A</sub> =25°C)     |                          | Red<br>(AlGaInP) | Unit |  |  |
|---|--------------------------|------------------|------|--|--|
| Reverse Voltage                                     | $V_{\rm R}$              | 0.5              | V    |  |  |
| Forward Voltage                                     | $V_{\mathrm{F}}$         | 14               | V    |  |  |
| Power Dissipation                                   | $P_{D}$                  | 310              | mW   |  |  |
| Operating Temperature                               | T <sub>A</sub> -40 ~ +70 |                  | °C   |  |  |
| Storage Temperature                                 | Tstg                     | -40 ~ +85        |      |  |  |
| Lead Solder Temperature<br>[2mm Below Package Base] | 260°C For 3 Seconds      |                  |      |  |  |
| Lead Solder Temperature<br>[5mm Below Package Base] | 260°C For 5 Seconds      |                  |      |  |  |

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

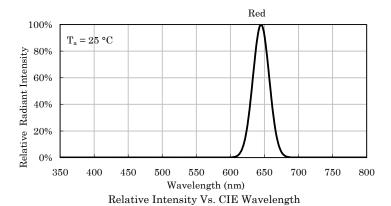
| Operating Characteristics (T <sub>A</sub> =25°C)       |                  | Red<br>(AlGaInP) | Unit |
|--|------------------|------------------|------|
| Forward Current (Min.) (V <sub>F</sub> =3.5V)          | $I_{\mathrm{F}}$ | 8                | mA   |
| Forward Current (Typ.)<br>(V <sub>F</sub> =5V)         | $I_{\mathrm{F}}$ | 22               | mA   |
| Supply Current (Typ.) $(V_F=3.5V)$                     | $I_{SON}$        | 8                | mA   |
| Supply Current (Typ.) (V <sub>F</sub> =14V)            | $I_{SON}$        | 44               | mA   |
| Blink Frequency (Min.~Max.) (V <sub>F</sub> =3.5V~14V) | f                | 1.5~3            | Hz   |
| Wavelength of Peak<br>Emission CIE127-2007* (Typ.)     | λΡ               | 645*             | nm   |
| Wavelength of Dominant Emission<br>CIE127-2007* (Typ.) | λD               | 630*             | nm   |
| Spectral Line Full Width At Half-Maximum (Typ.)        | Δλ               | 28               | nm   |

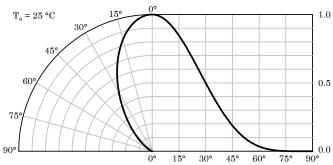
| Part<br>Number | Emitting<br>Color | Emitting<br>Material | Lens-color   | Luminous Intensity CIE127-2007* (V <sub>F</sub> =9V) mcd |             | Wavelength<br>CIE127-2007*<br>nm<br>λP | Viewing<br>Angle<br>2θ 1/2 |
|----------------|-------------------|----------------------|--------------|--|-------------|--|----------------------------|
|                |                   |                      |              | min.   | typ.        |  |                            |
| XBMDK53D       | Red               | AlGaInP              | Red Diffused | 400<br>120*  | 795<br>297* | 645*                                   | 60°                        |

<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.



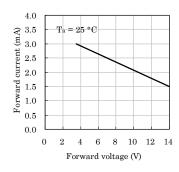


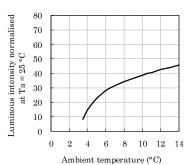




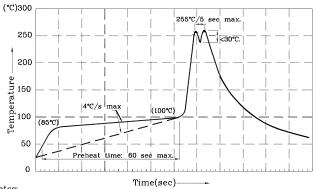
Spatial Distribution

# **❖** Red





Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



- Notes: 1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec
- (8 sec max).

  3.Do not apply stress to the epoxy resin while the temperature is above 85°C.

  4. Fixtures should not incur stress on the component when mounting and during soldering process.

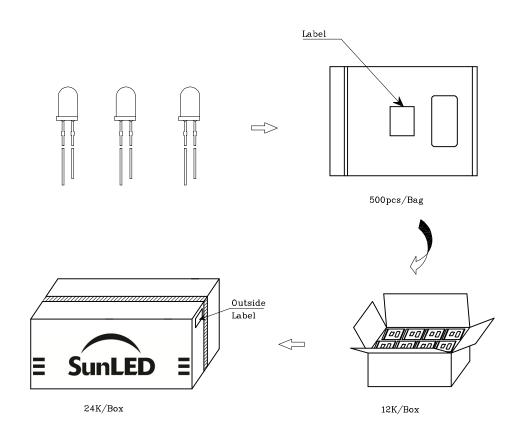
  5.SAC 305 solder alloy is recommended.

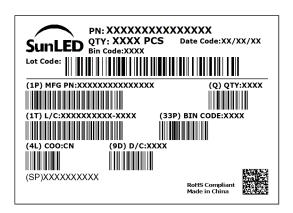
  6.No more than one wave soldering pass.





# PACKING & LABEL SPECIFICATIONS





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